#### 503904123 07/07/2016

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
HIDEKAZU MIYAIRI	12/10/2014
SHUNPEI YAMAZAKI	12/08/2014

### **RECEIVING PARTY DATA**

Name:	SEMICONDUCTOR ENERGY LABORATORY CO., LTD.
Street Address:	398, HASE
City:	ATSUGI-SHI, KANAGAWA-KEN
State/Country:	JAPAN
Postal Code:	243-0036

# **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15163799

#### CORRESPONDENCE DATA

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Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

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ATTORNEY DOCKET NUMBER:	12732-1391002
NAME OF SUBMITTER:	JANELLE A. JACKSON
SIGNATURE:	/Janelle A. Jackson/
DATE SIGNED:	07/07/2016

**Total Attachments: 1** 

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**PATENT** REEL: 039094 FRAME: 0727 503904123

## **ASSIGNMENT**

For valuable consideration, We, <u>Hidekazu MIYAIRI of Hadano, Kanagawa, Japan and Shunpei YAMAZAKI of Setagaya, Tokyo, Japan hereby assign to Semiconductor Energy Laboratory Co., Ltd., a <u>Japanese</u> corporation having a place of business at:</u>

398, Hase, Atsugi-shi, Kanagawa-ken, 243-0036 Japan

and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title ar
interest throughout the world in the inventions and improvements which are subject of an application for
United States Patent signed by us this day, entitled SEMICONDUCTOR DEVICE
filed December 22, 2014, and assigned U.S. Serial Number 14/578,919, and w
authorize and request the attorneys appointed in said application to hereafter complete this assignment b
inserting above the filing date and serial number of said application when known; this assignment including
said application, any and all United States and foreign patents, utility models, and design registration
granted for any of said inventions or improvements, and the right to claim priority based on the filing date of
said application under the International Convention for the Protection of Industrial Property, the Pater
Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and w
authorize the Assignee to apply in all countries in our name or in its own name for patents, utility models
design registrations and like rights of exclusion and for inventors' certificates for said inventions an
improvements; and we agree for ourselves and our respective heirs, legal representatives and assigns
without further compensation to perform such lawful acts and to sign such further applications, assignments
Preliminary Statements and other lawful documents as the Assignee may reasonably request to effectuat
fully this assignment.

Signature //idefazu M/7A/R/
Name: Hidekazu MIYAIRI
Date: /2//0/2014

Signature Shunpei YAMAZAKI
Date: /2/08/2014

**RECORDED: 07/07/2016** 

PATENT REEL: 039094 FRAME: 0728